

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 50mA		Viewing Angle
			Min.	Typ.	2θ1/2
AA5060SURC/G	HYPHER RED (InGaAlP)	WATER CLEAR	480	750	100°

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Electrical / Optical Characteristics at TA=25°C

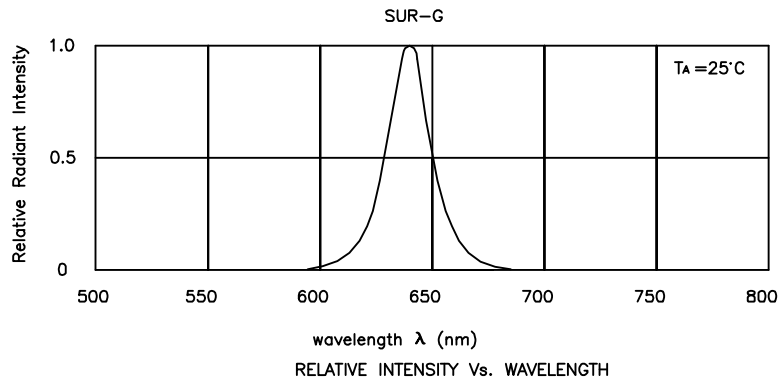
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD	Dominant Wavelength	Hyper Red	630		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	22		nm	IF=20mA
C	Capacitance	Hyper Red	45		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.9	2.5	V	IF=20mA
IR	Reverse Current	Hyper Red		10	uA	VR = 5V

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units
Power dissipation	100	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

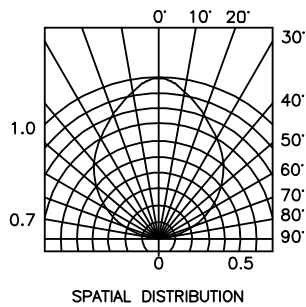
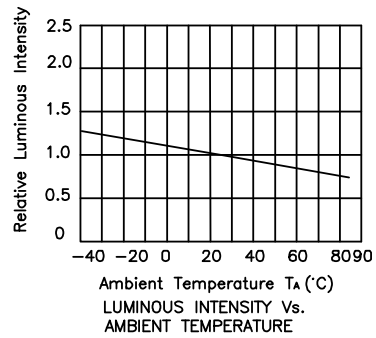
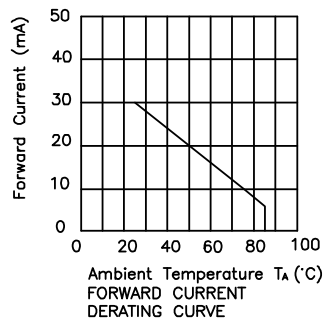
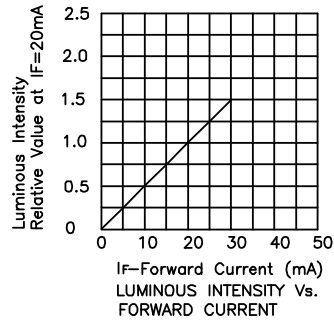
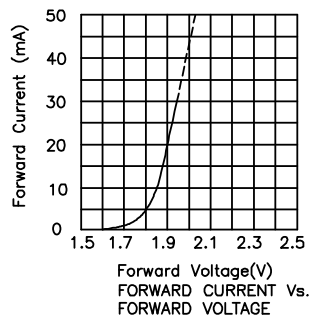
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



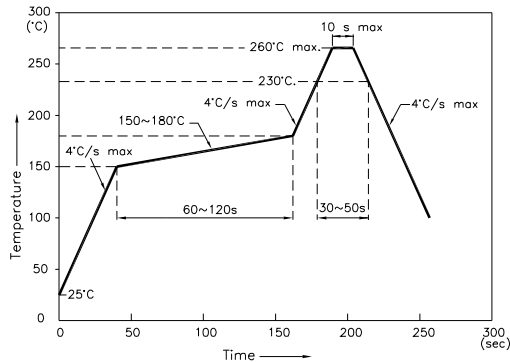
Hyper Red

AA5060SURC/G



AA5060SURC/G

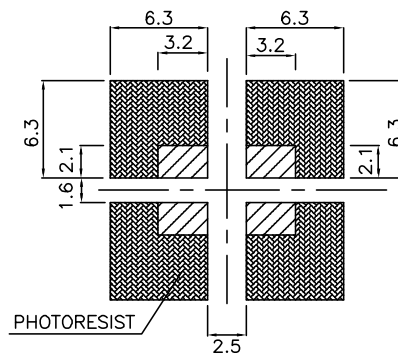
Reflow Soldering Profile For Lead-free SMT Process.



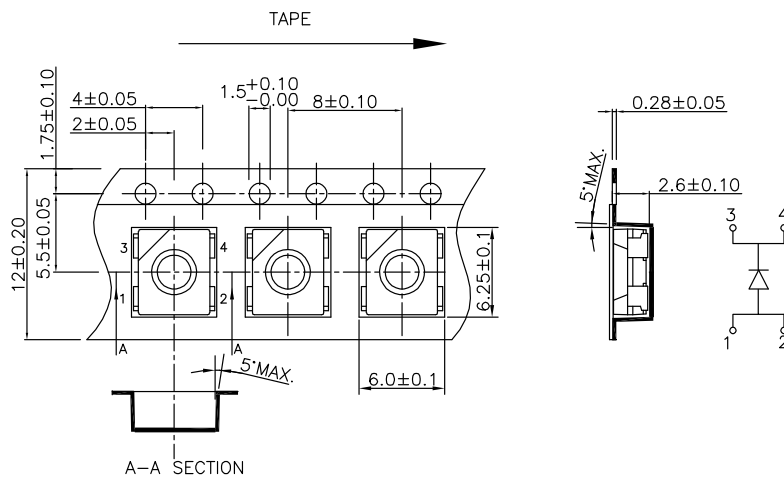
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm)



Tape Specifications (Units : mm)



Remarks:

If there is sorting requirement (eg. forward voltage, luminous intensity or wavelength), the condition as follows:

1. Wavelength: +/-1nm (Test condition is based on the sorting standard).
2. Luminous intensity: +/-15% (Test condition is based on the sorting standard).
3. Forward voltage: +/-0.1V (Test condition is based on the sorting standard).